

## **Features**

- Glass Passivated Junction
- Lead Free Finish/RoHS Compliant (Note 1)("P" Suffix Designates RoHS Compliant. See Ordering Information)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free. "Green" Device (Note 2)
- Moisture Sensitivity Level 1
- Low Profile Package

# 4 Amp Super Fast Recovery Rectifier 600 Volts

# Maximum Ratings @ 25°C (Unless Otherwise Specified)

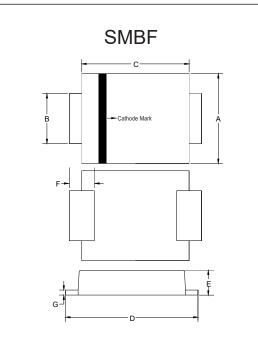
Parameter	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>		V	
Working Peak Reverse Voltage	V <sub>RWM</sub>	600		
DC Blocking Voltage	V <sub>R</sub>			
RMS Reverse Voltage	V <sub>RMS</sub>	420	V	
Average Rectified Forward Current @ T <sub>L</sub> =50°C	I <sub>F(AV)</sub>	4	Α	
Non-Repetitive Peak Surge Current @8.3ms Half Sine Wave		100	А	
Non-Repetitive Peak Surge Current @1ms Square Wave	· I <sub>FSM</sub>	200	A	
Current Squared Time @ 1ms≤t≤8.3ms	l <sup>2</sup> t	41.5	A <sup>2</sup> s	

# **Internal Structure**

Pin	Description	Simplified Outline	Graphic Symbol
1	Cathode	, MCC	
2	Anode	MURS4J 2	1 0———— 0 2

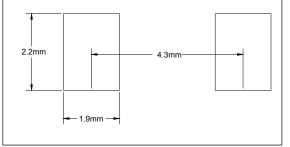
#### Note:

- 1. High temperature solder exemption applied, see EU directive annex 7a.
- 2. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



DIMENSIONS							
DIM	INCHES		М	М	NOTE		
DIIVI	MIN	MAX	MAX MIN MA		INOTE		
Α	0.134	0.150	3.40	3.80			
В	0.075	0.083	1.90	2.10			
С	0.163	0.175	4.15	4.45			
D	0.201	0.220	5.10	5.60			
Е	0.041	0.061	1.05	1.55			
F	0.028	0.053	0.70	1.35			
G	0.006	0.010	0.15	0.25			

#### Suggested Solder Pad Layout



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# Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$T_J$	Operating Junction Temperature Range		-55		150	°C
T <sub>stg</sub>	Storage Temperature Range		-55		150	°C
Rth <sub>(J-L)</sub>	Thermal Resistance from Junction to Lead	Note 1		20		°C/W
Rth <sub>(J-A)</sub>	Thermal Resistance from Junction to Ambient	Note 1		60		°C/W

#### Note:

# Electrical Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =4A;T <sub>J</sub> =25°C			1.25	V
Reverse Current	I <sub>R</sub>	at Rated $V_R;T_J=25^{\circ}C$ at Rated $V_R;T_J=125^{\circ}C$			5 50	μA
Junction Capacitance	CJ	V <sub>R</sub> =4V;f=1MHz;T <sub>J</sub> =25°C		50		pF

# Dynamic Recovery Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
		I <sub>F</sub> =0.5A; I <sub>R</sub> =1.0A;I <sub>RR</sub> =0.25A;T <sub>J</sub> =25°C				50	
		I <sub>F</sub> =1A,di/dt=-50A/us,V <sub>R</sub> =30V;T <sub>J</sub> =25°C			49		
Reverse Recovery Time	t <sub>rr</sub>		T <sub>J</sub> =25°C		50		ns
			T <sub>J</sub> =125°C		77		
Dools Dooossons Comment	I <sub>RRM</sub>	l <sub>F</sub> =4Α di/dt=-200Α/μs	T <sub>J</sub> =25°C		6.6		Α
Peak Recovery Current		V <sub>R</sub> =400 V	T <sub>J</sub> =125°C		10		A
Deviates Deservery Charge	0		T <sub>J</sub> =25°C		168		nC
Reverse Recovery Charge Q <sub>rr</sub>			T <sub>J</sub> =125°C		382		ПС

<sup>1.</sup> Mounted on P.C.B. with 8mm\*8mm copper pad areas.



## **Curve Characteristics**

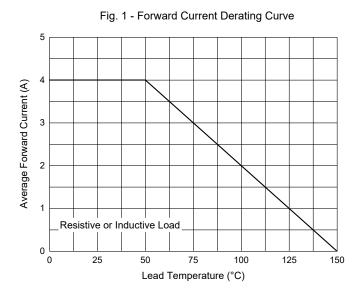


Fig. 3 - Typical Instantaneous Forward Characteristics

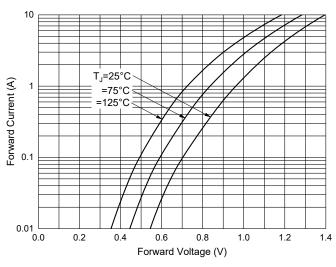


Fig. 5 - Typical Capacitance Characteristics

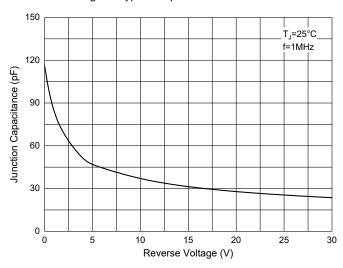


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge

Current

120

(V) 100

80

40

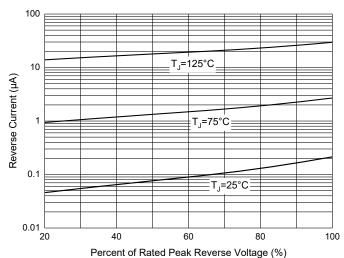
40

8.3ms Half Sine Wave

0 1 10 100

Number of Cycles at 60 Hz

Fig. 4 - Typical Reverse Leakage Characteristics





## **Ordering Information**

Device	Packing		
MURS4JBFL-TP	Tape&Reel:5Kpcs/Reel		

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